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Details

Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	48
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f523t3adfm-30

1.3 Block Diagram

Figure 1.2 shows a block diagram.

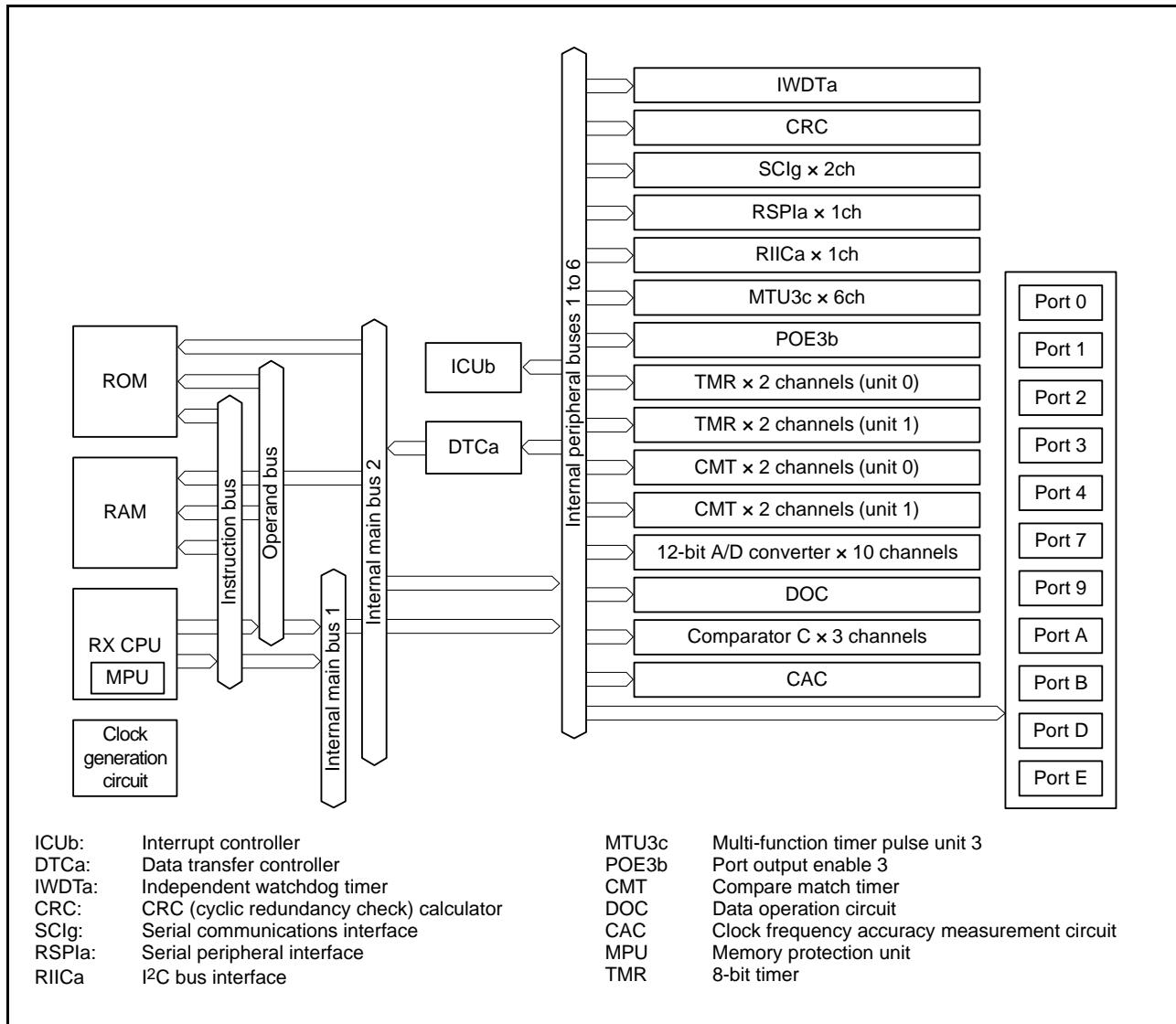


Figure 1.2 Block Diagram

Table 1.7 List of Pins and Pin Functions (52-Pin LQFP)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE, CAC)	Communications (SCIg, RSPI, IIC)	Others
1		P02		CTS1#/RTS1#/SS1#	ADST0/IRQ5
2	VCL				
3	MD				FINED
4	RES#				
5	XTAL	P37			
6	VSS				
7	EXTAL	P36			
8	VCC				
9		PE2	POE10#		NMI
10		PD6	TMO1	SSLA0/CTS1#/RTS1#/SS1#	ADST0/IRQ5
11		PD5	TMR10	RXD1/SMISO1/SSCL1	IRQ3
12		PD4	TMCI0	SCK1	IRQ2
13		PD3	TMO0	TXD1/SMOSI1/SSDA1	
14		PB7		SCK5	
15		PB6		RXD5/SMISO5/SSCL5	IRQ5
16		PB5		TXD5/SMOSI5/SSDA5	
17	VCC				
18		PB4	POE8#		IRQ3
19		PB3	MTIOC0A/CACREF	SCK5/RSPCKA	
20		PB2	MTIOC0B/ADSM0	TXD5/SMOSI5/SSDA5/SDA0	
21		PB1	MTIOC0C	RXD5/SMISO5/SSCL5/SCL0	IRQ2
22		PB0	MTIOC0D	MOSIA	
23		PA3	MTIOC2A	SSLA0	
24		PA2	MTIOC2B	CTS5#/RTS5#/SS5#/SSLA1	IRQ4
25		P94	MTIOC0C/TMO1	MISOA	IRQ1
26		P93	MTIOC0B/TMR1	SCK5/RSPCKA	IRQ0
27		P76	MTIOC4D		
28		P75	MTIOC4C		
29		P74	MTIOC3D		
30		P73	MTIOC4B		
31		P72	MTIOC4A		
32		P71	MTIOC3B		
33		P70	POE0#		IRQ5
34		P33	MTIOC3A/MTCLKA	SSLA3	
35	VCC				
36	VSS				
37		P24	MTIC5U/TMCI2	RSPCKA	COMP0/IRQ3
38		P23	MTIC5V/CACREF/TMO2	MOSIA	COMP1/IRQ4
39		P22	MTIC5W/TMR12	MISOA	COMP2/IRQ2
40		P47			AN007/CMPC12/CMPC22
41		P46			AN006/CMPC02
42		P45			AN005/CMPC21
43		P44			AN004/CMPC11
44		P43			AN003/CMPC01
45		P42			AN002/CMPC20
46		P41			AN001/CMPC10
47		P40			AN000/CMPC00
48	AVCC0				
49	AVSS0				
50		P11	MTIOC3A/MTCLKC/TMO3		IRQ1/AN016/CVREFC0
51		P10	MTCLKD/TMR13		IRQ0/AN017/CVREFC1
52		PA5	MTIOC1A/TMCI3	MISOA	

Table 1.8 List of Pins and Pin Functions (48-Pin LFQFP)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE, CAC)	Communications (SCIg, RSPI, IIC)	Others
1	VCL				
2	MD				FINED
3	RES#				
4	XTAL	P37			
5	VSS				
6	EXTAL	P36			
7	VCC				
8		PE2	POE10#		NMI
9		PD6	TMO1	SSLA0/CTS1#/RTS1#/SS1#	ADST0/IRQ5
10		PD5	TMR10	RXD1/SMISO1/SSCL1	IRQ3
11		PD4	TMC10	SCK1	IRQ2
12		PD3	TMO0	TXD1/SMOSI1/SSDA1	
13		PB6		RXD5/SMISO5/SSCL5	IRQ5
14		PB5		TXD5/SMOSI5/SSDA5	
15	VCC				
16		PB4	POE8#		IRQ3
17		PB3	MTIOC0A/CACREF	SCK5/RSPCKA	
18		PB2	MTIOC0B/ADSM0	TXD5/SMOSI5/SSDA5/SDA0	
19		PB1	MTIOC0C	RXD5/SMISO5/SSCL5/SCL0	IRQ2
20		PB0	MTIOC0D	MOSIA	
21		PA3	MTIOC2A	SSLA0	
22		PA2	MTIOC2B	CTS5#/RTS5#/SS5#/SSLA1	IRQ4
23		P94	MTIOC0C/TMO1	MISOA	IRQ1
24		P93	MTIOC0B/TMR1	SCK5/RSPCKA	IRQ0
25		P76	MTIOC4D		
26		P75	MTIOC4C		
27		P74	MTIOC3D		
28		P73	MTIOC4B		
29		P72	MTIOC4A		
30		P71	MTIOC3B		
31		P70	POE0#		IRQ5
32	VCC				
33	VSS				
34		P24	MTIC5U/TMCI2	RSPCKA	COMP0/IRQ3
35		P23	MTIC5V/CACREF/TMO2	MOSIA	COMP1/IRQ4
36		P22	MTIC5W/TMR12	MISOA	COMP2/IRQ2
37		P47			AN007/CMPC12/CMPC22
38		P46			AN006/CMPC02
39		P45			AN005/CMPC21
40		P44			AN004/CMPC11
41		P43			AN003/CMPC01
42		P42			AN002/CMPC20
43		P41			AN001/CMPC10
44		P40			AN000/CMPC00
45	AVCC0				
46	AVSS0				
47		P11	MTIOC3A/MTCLKC/TMO3		IRQ1/AN016/CVREFC0
48		P10	MTCLKD/TMR13		IRQ0/AN017/CVREFC1

2. CPU

Figure 2.1 shows register set of the CPU.

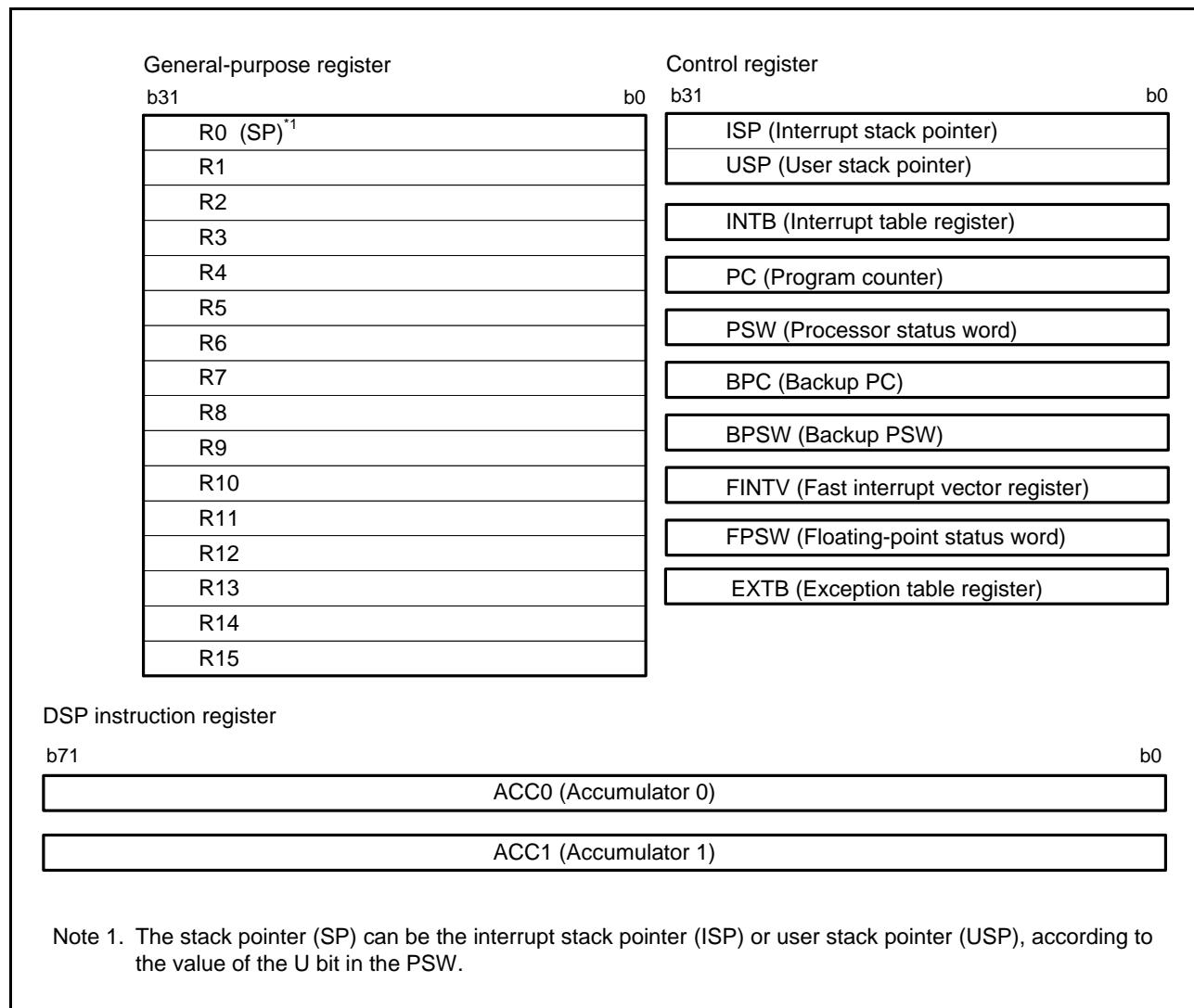


Figure 2.1 Register Set of the CPU

3. Address Space

3.1 Address Space

This LSI has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.

Figure 3.1 shows the memory maps in the respective operating modes. Accessible areas will differ according to the operating mode and states of control bits.

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = VREFL0 = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC	-0.3 to +6.5	V
Input voltage	Port 4	V _{in}	-0.3 to AVCC0+0.3	V
	Except for port 4 and ports for 5 V tolerant* ¹		-0.3 to VCC+0.3	V
	Ports for 5 V tolerant* ¹		-0.3 to +6.5	V
Reference power supply voltage		VREFH0	-0.3 to AVCC0+0.3	V
Analog power supply voltage		AVCC0	-0.3 to +6.5	V
Analog input voltage	When AN000 to AN007 used	V _{AN}	-0.3 to AVCC0+0.3	V
	When AN016 and AN017 used		-0.3 to VCC+0.3	
Operating temperature* ²		T _{opr}	-40 to +85 -40 to +105	°C
Storage temperature		T _{stg}	-55 to +125	°C

Caution: Permanent damage to the MCU may result if absolute maximum ratings are exceeded.

To preclude any malfunctions due to noise interference, insert capacitors of high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, between the VREFH0 and VREFL0 pins. Place capacitors of about 0.1 µF as close as possible to every power supply pin and use the shortest and heaviest possible traces.

Connect the VCL pin to a VSS pin via a 4.7 µF capacitor. The capacitor must be placed close to the pin.

Do not input signals or an I/O pull-up power supply to ports other than 5-V tolerant ports while the device is not powered.

The current injection that results from input of such a signal or I/O pull-up may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements.

Even if -0.3 to +6.5 V is input to 5-V tolerant ports, it will not cause problems such as damage to the MCU.

Note 1. Ports B1 and B2 are 5 V tolerant.

Note 2. The upper limit of operating temperature is 85°C or 105°C, depending on the product. For details, refer to section 1.2, List of Products.

Table 5.2 Recommended Operating Voltage Conditions

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power supply voltages	VCC* ¹ , * ²		2.7	—	5.5	V
	VSS		—	0	—	
Analog power supply voltages	AVCC0* ¹ , * ²		VCC	—	5.5	V
	VREFH0* ¹ , * ²		—	AVCC0	—	
	AVSS0, VREFL0		—	0	—	

Note 1. AVCC0/VREFH0 and VCC can be set individually within the operating range.

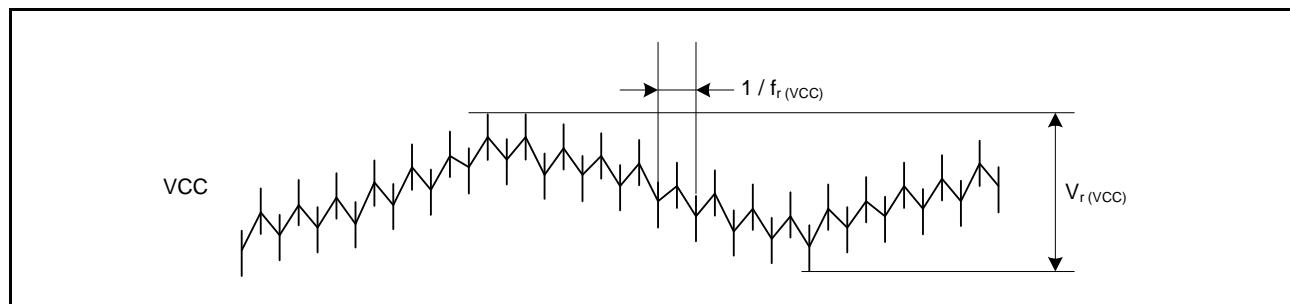
Note 2. When powering on the VCC and AVCC0/VREFH0 pins, power them on at the same time or the VCC pin first and then the AVCC0/VREFH0 pin.

Table 5.10 DC Characteristics (8)

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, $T_a = -40$ to $+105^\circ\text{C}$

The ripple voltage must meet the allowable ripple frequency $f_r(VCC)$ within the range between the VCC upper limit (5.5 V) and lower limit (2.7 V). When VCC change exceeds VCC $\pm 10\%$, the allowable voltage change rising/falling gradient $dt/dVCC$ must be met.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Allowable ripple frequency	$f_r(VCC)$	—	—	10	kHz	Figure 5.3 $V_r(VCC) \leq VCC \times 0.2$
		—	—	1	MHz	Figure 5.3 $V_r(VCC) \leq VCC \times 0.08$
		—	—	10	MHz	Figure 5.3 $V_r(VCC) \leq VCC \times 0.06$
Allowable voltage change rising/falling gradient	$dt/dVCC$	1.0	—	—	ms/V	When VCC change exceeds VCC $\pm 10\%$

**Figure 5.3 Ripple Waveform****Table 5.11 DC Characteristics (9)**

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, $T_a = -40$ to $+105^\circ\text{C}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Permissible error of VCL pin external capacitance	C_{VCL}	3.3	4.7	6.1	μF	

Note: The recommended capacitance is 4.7 μF . Variations in connected capacitors should be within the above range.

Table 5.12 Permissible Output Currents

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, $T_a = -40$ to $+105^\circ\text{C}$

Item	Symbol	Max.	Unit
Permissible output low current	I_{OL}	10.0	mA
		6.0	
		4.0	
		8.0	
		50	
Permissible output low current	ΣI_{OL}	110	
		50	
Permissible output high current	I_{OH}	-5.0	
		-4.0	
		-8.0	
		-25	
Permissible output high current	ΣI_{OH}	-35	
		-25	

Note: Do not exceed the permissible total supply current.

5.2.2 Standard I/O Pin Output Characteristics (2)

Figure 5.8 to Figure 5.11 show the characteristics when high-drive output is selected by the drive capacity control register.

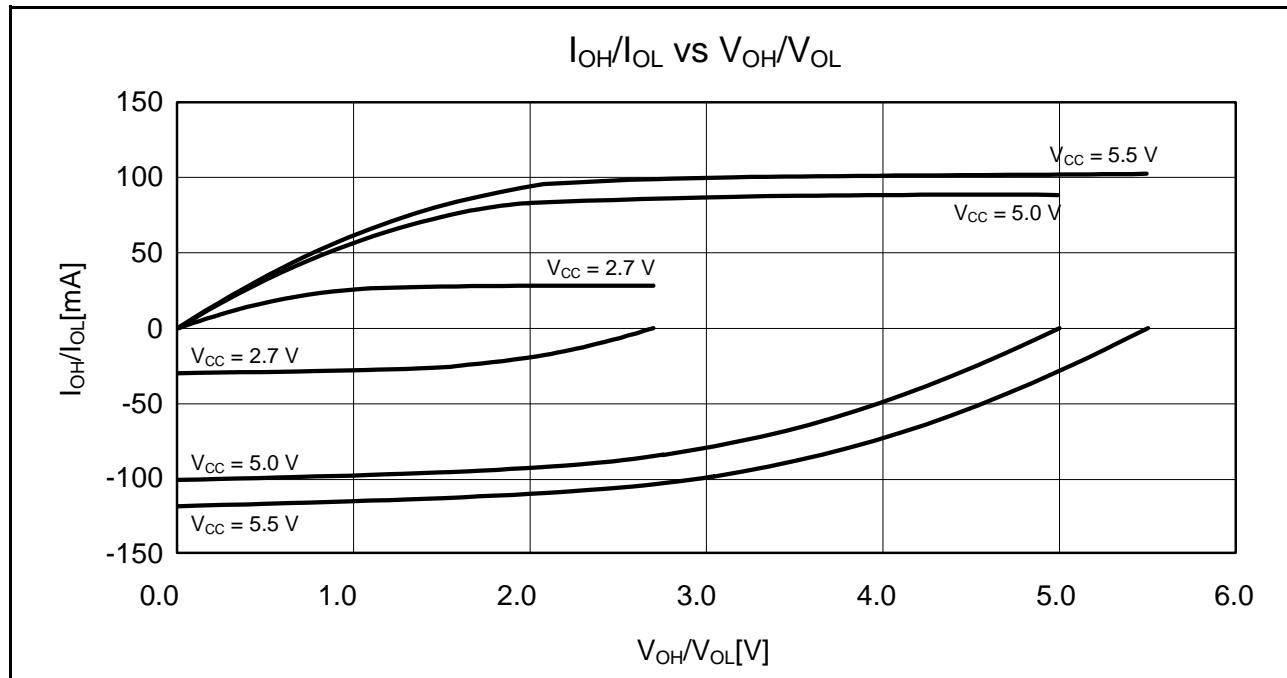


Figure 5.8 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics at $T_a = 25^\circ\text{C}$ When Normal Output is Selected (Reference Data)

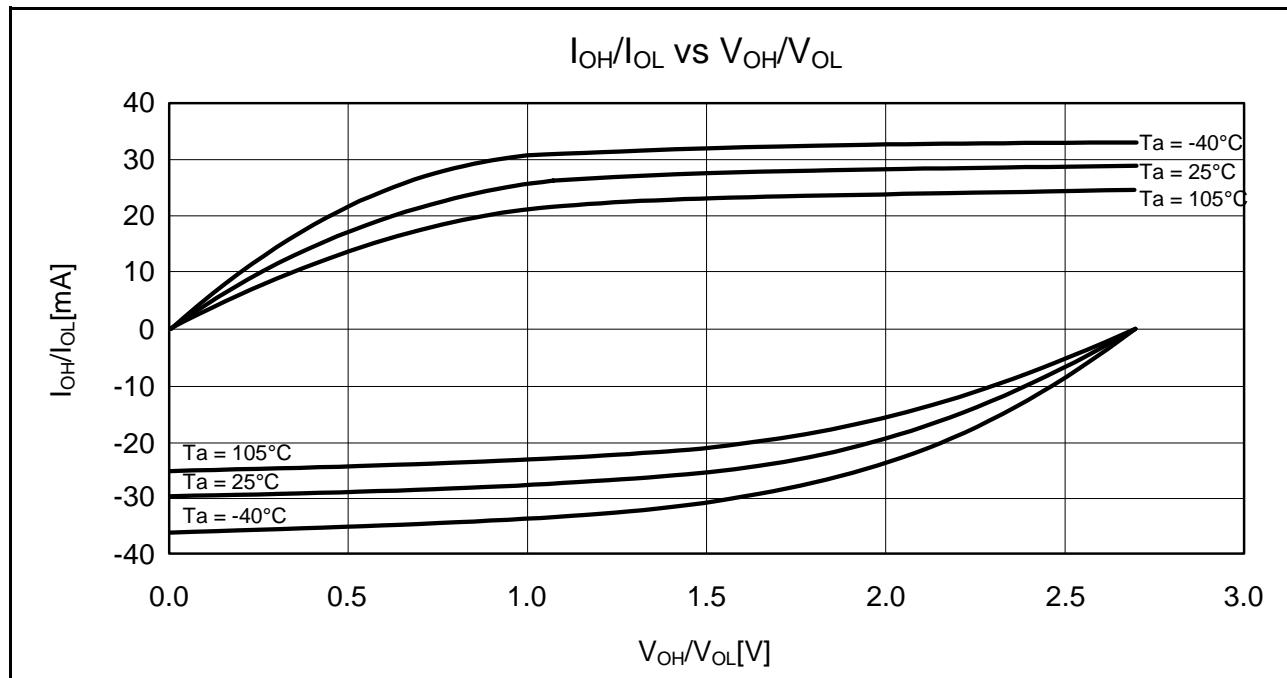


Figure 5.9 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 2.7\text{ V}$ when Normal Output is Selected (Reference Data)

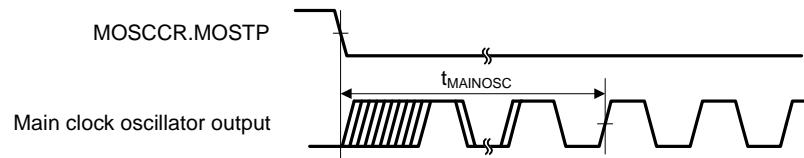


Figure 5.21 Main Clock Oscillation Start Timing

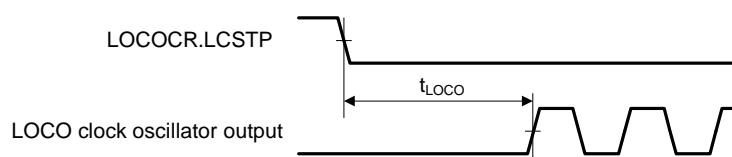


Figure 5.22 LOCO Clock Oscillation Start Timing

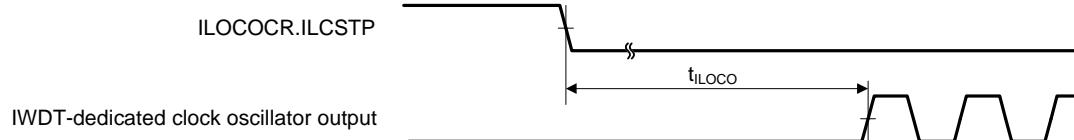


Figure 5.23 IWDT-Dedicated Clock Oscillation Start Timing

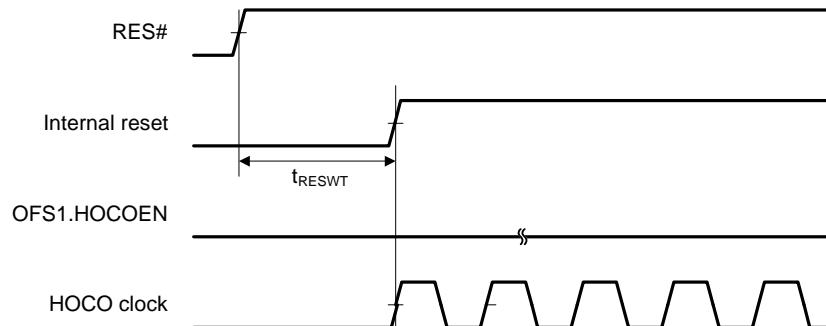


Figure 5.24 HOCO Clock Oscillation Start Timing (After Reset is Canceled by Setting OFS1.HOCOEN Bit to 0)

5.3.2 Reset Timing

Table 5.17 Reset Timing

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, Ta = -40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width At power-on	t _{RESWP}	3	—	—	ms	Figure 5.27
	t _{RESW}	30	—	—	μs	
Wait time after RES# cancellation (at power-on)	t _{RESWT}	—	27.5	—	ms	Figure 5.27
Wait time after RES# cancellation (during powered-on state)	t _{RESWT}	—	114	—	μs	Figure 5.28
Independent watchdog timer reset period	t _{RESWIW}	—	1	—	IWDT clock cycle	Figure 5.29
Software reset period	t _{RESWSW}	—	1	—	ICLK cycle	
Wait time after independent watchdog timer reset cancellation*1	t _{RESW2}	—	300	—	μs	
Wait time after software reset cancellation	t _{RESW2}	—	168	—	μs	

Note 1. When IWDTCR.CKS[3:0] = 0000b.

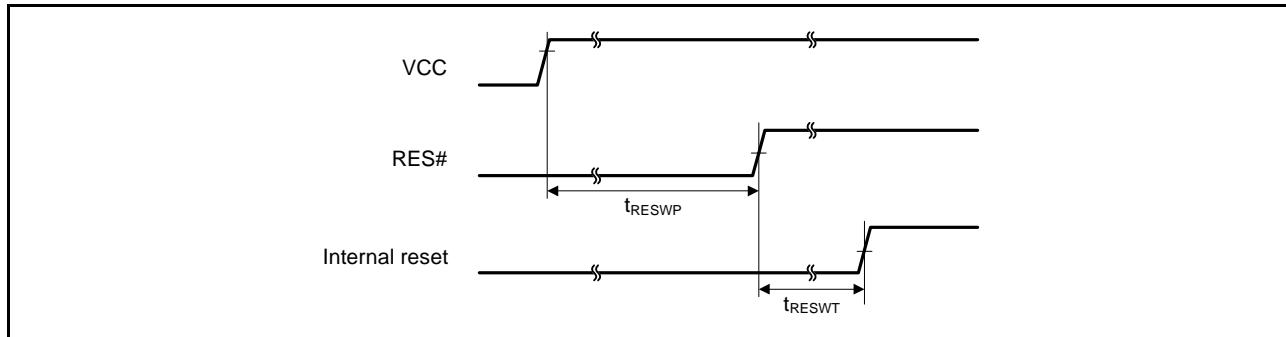


Figure 5.27 Reset Input Timing at Power-On

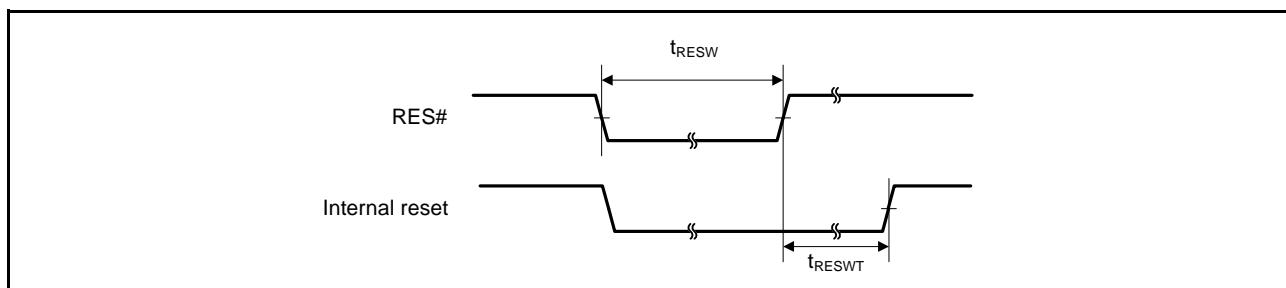


Figure 5.28 Reset Input Timing (1)

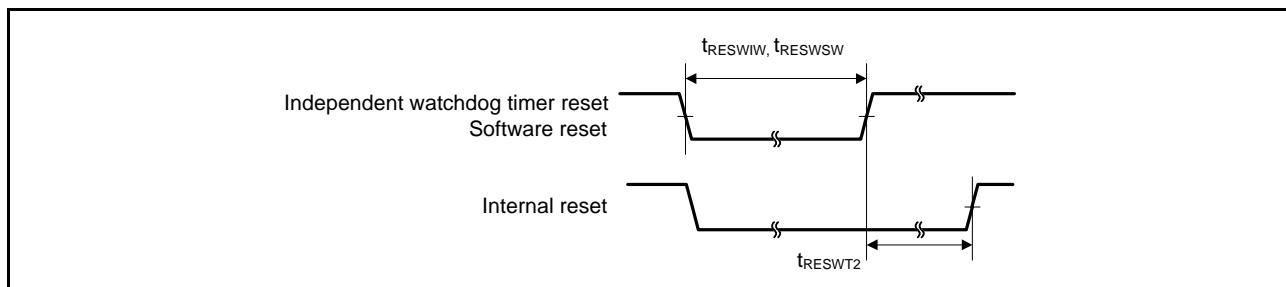


Figure 5.29 Reset Input Timing (2)

Table 5.25 Timing of On-Chip Peripheral Modules (3)

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, T_a = -40 to +105°C, C = 30pF

Item		Symbol	Min.	Max.	Unit*1	Test Conditions	
Simple SPI	SCK clock cycle output (master)	t _{SPcyc}	4	65536	t _{Pcyc}	Figure 5.42	
	SCK clock cycle input (slave)		6	65536	t _{Pcyc}		
	SCK clock high pulse width	t _{SPCKWH}	0.4	0.6	t _{SPcyc}		
	SCK clock low pulse width	t _{SPCKWL}	0.4	0.6	t _{SPcyc}		
	SCK clock rise/fall time	t _{SPCKr} , t _{SPCKf}	—	20	ns		
	Data input setup time (master)	t _{su}	40	—	ns	Figure 5.43, Figure 5.44	
			65	—	ns		
			40	—	ns		
	Data input hold time	t _H	40	—	ns		
	SS input setup time	t _{LEAD}	3	—	t _{SPcyc}		
	SS input hold time	t _{LAG}	3	—	t _{SPcyc}		
	Data output delay time (master)	t _{OD}	—	40	ns		
	Data output delay time (slave)		—	40	ns		
			—	65	ns		
	Data output hold time (master)	t _{OH}	-10	—	ns		
			-10	—	ns		
	Data rise/fall time	t _{Dr} , t _{Df}	—	20	ns		
	SS input rise/fall time	t _{SSLr} , t _{SSLf}	—	20	ns		
	Slave access time	t _{SA}	—	6	t _{Pcyc}	Figure 5.45, Figure 5.46	
	Slave output release time	t _{REL}	—	6	t _{Pcyc}		

Note 1. t_{Pcyc}: PCLK cycle

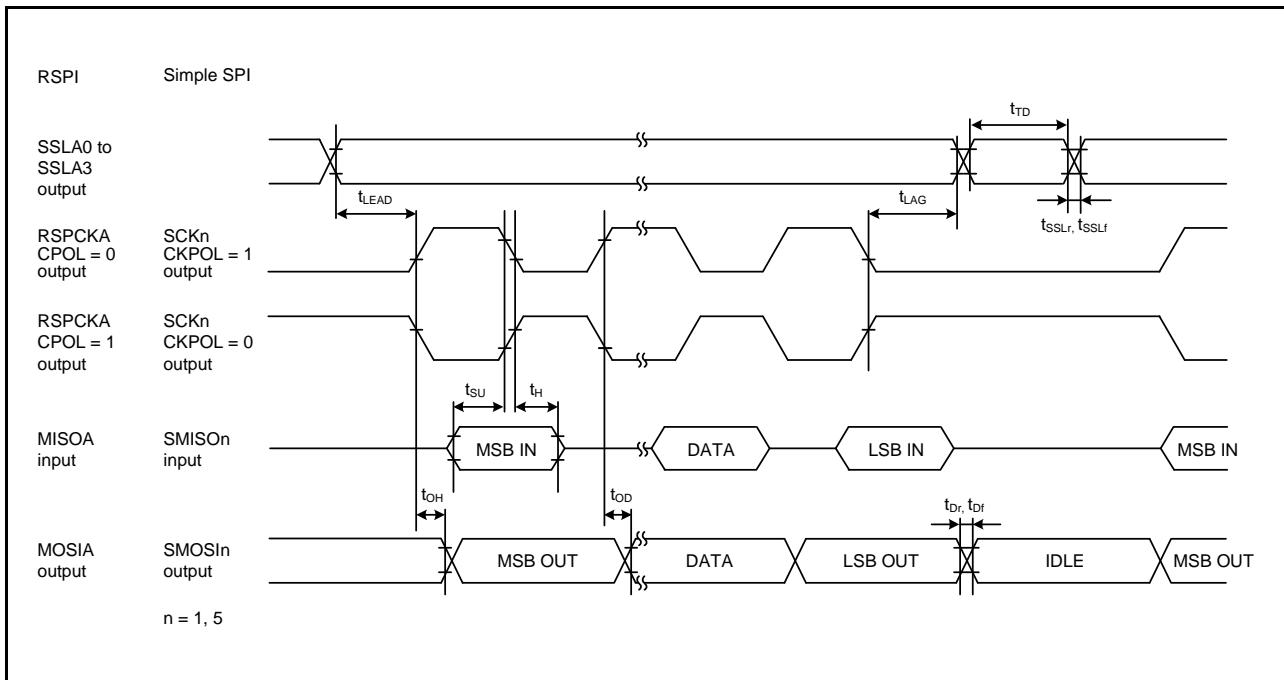


Figure 5.44 RSPI Timing (Master, CPHA = 1) and Simple SPI Clock Timing (Master, CKPH = 0)

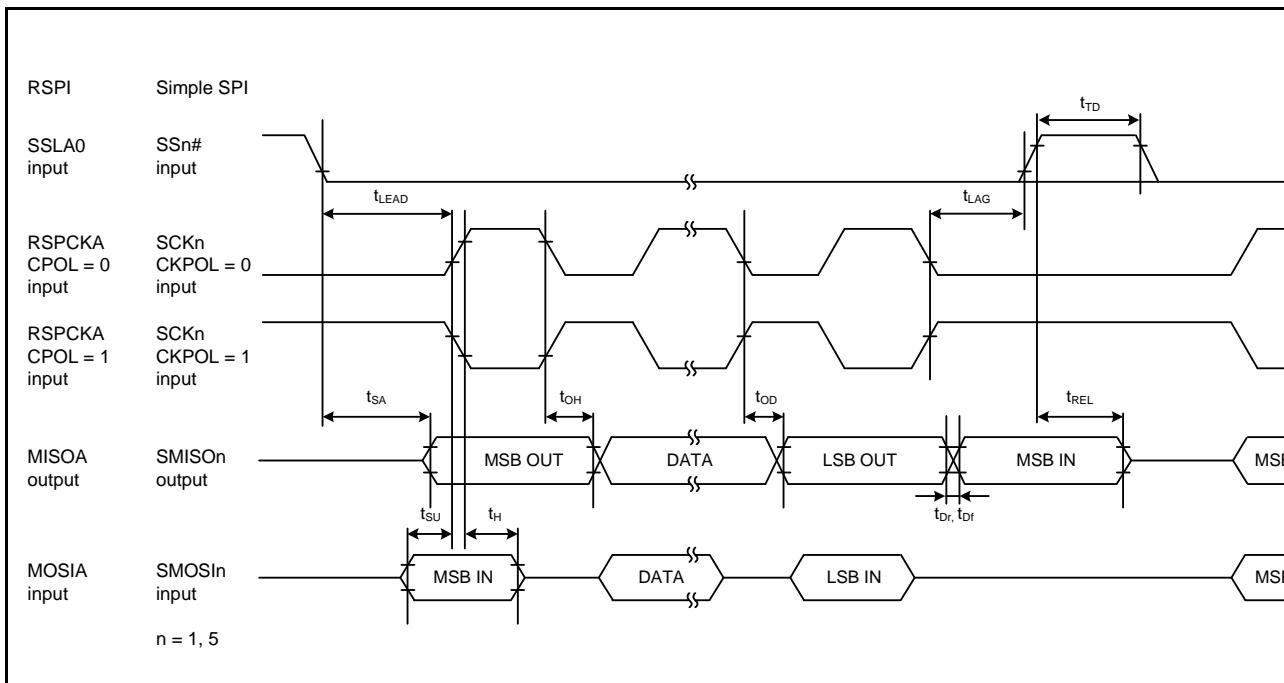


Figure 5.45 RSPI Timing (Slave, CPHA = 0) and Simple SPI Clock Timing (Slave, CKPH = 1)

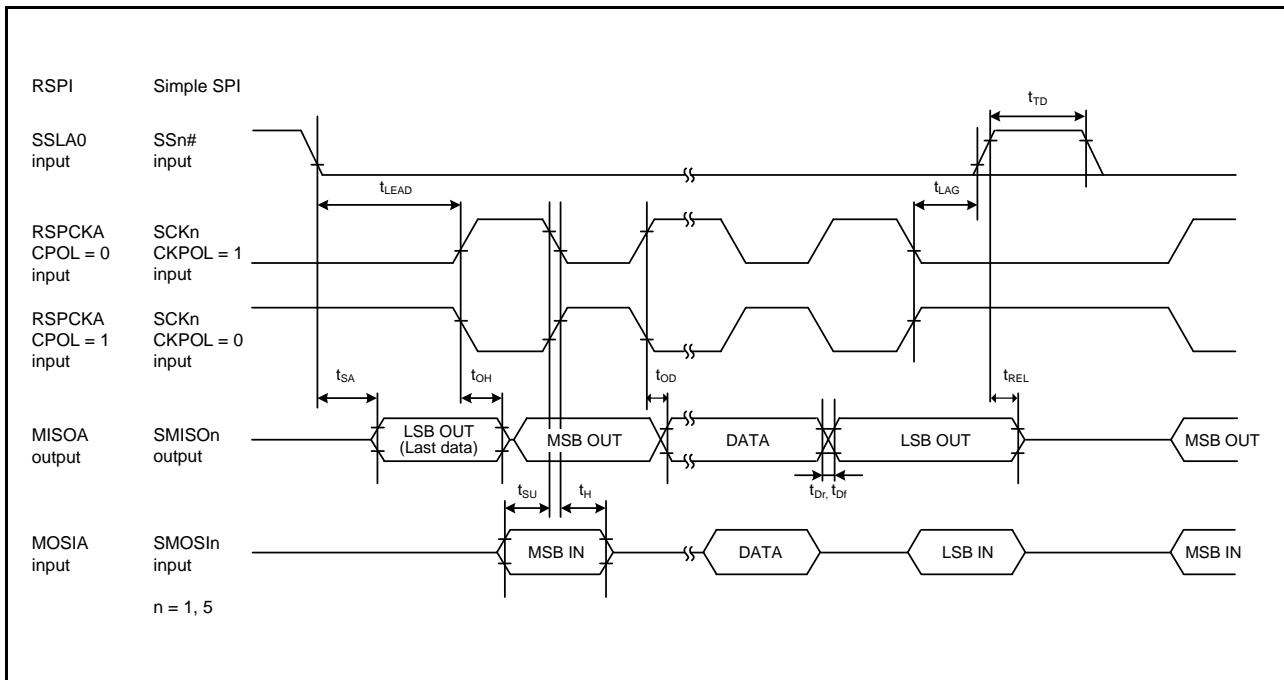
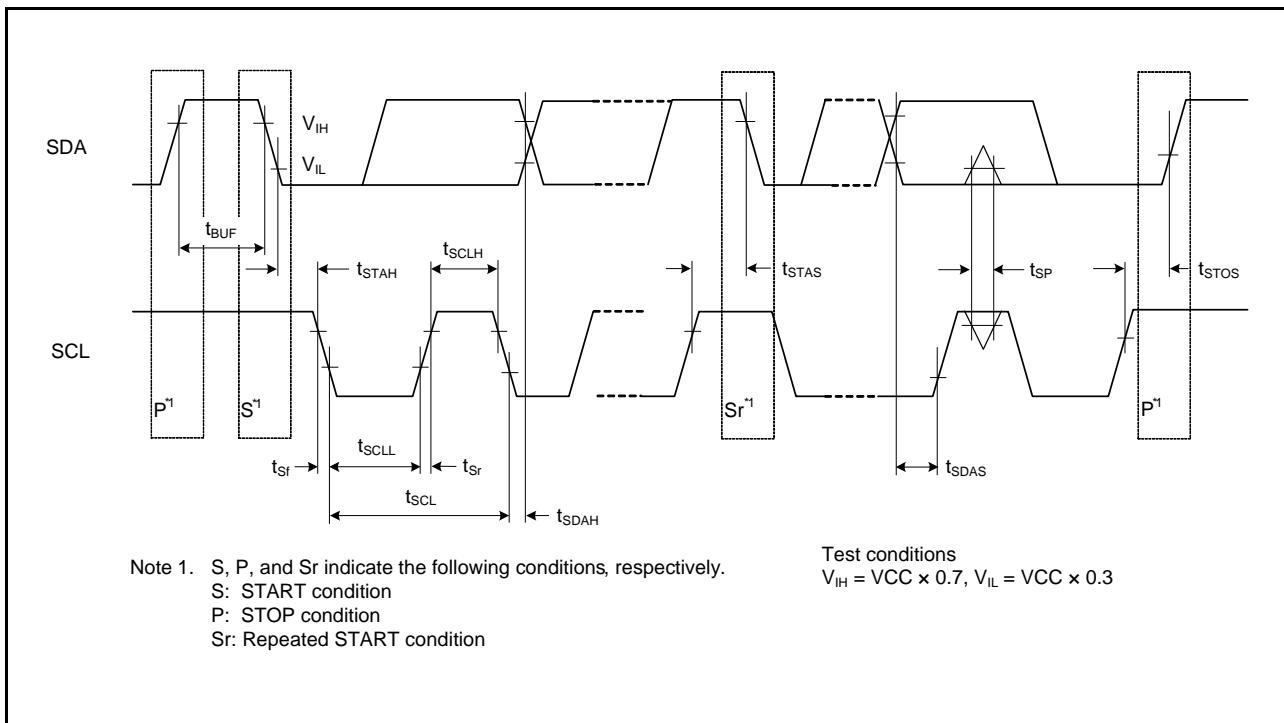


Figure 5.46 RSPI Timing (Slave, CPHA = 1) and Simple SPI Clock Timing (Slave, CKPH = 0)

Figure 5.47 RIIC Bus Interface Input/Output Timing and Simple I²C Bus Interface Input/Output Timing

Differential nonlinearity error (DNL)

Differential nonlinearity error is the difference between 1 LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

Offset error

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

Full-scale error

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

5.7 Power-On Reset Circuit and Voltage Detection Circuit Characteristics

Table 5.34 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (1)

Conditions: VCC = 2.7 V to 5.5 V, AVCC0 = VREFH0 = VCC to 5.5 V, VSS = AVSS0 = VREFL0 = 0 V, Ta = -40 to +105°C

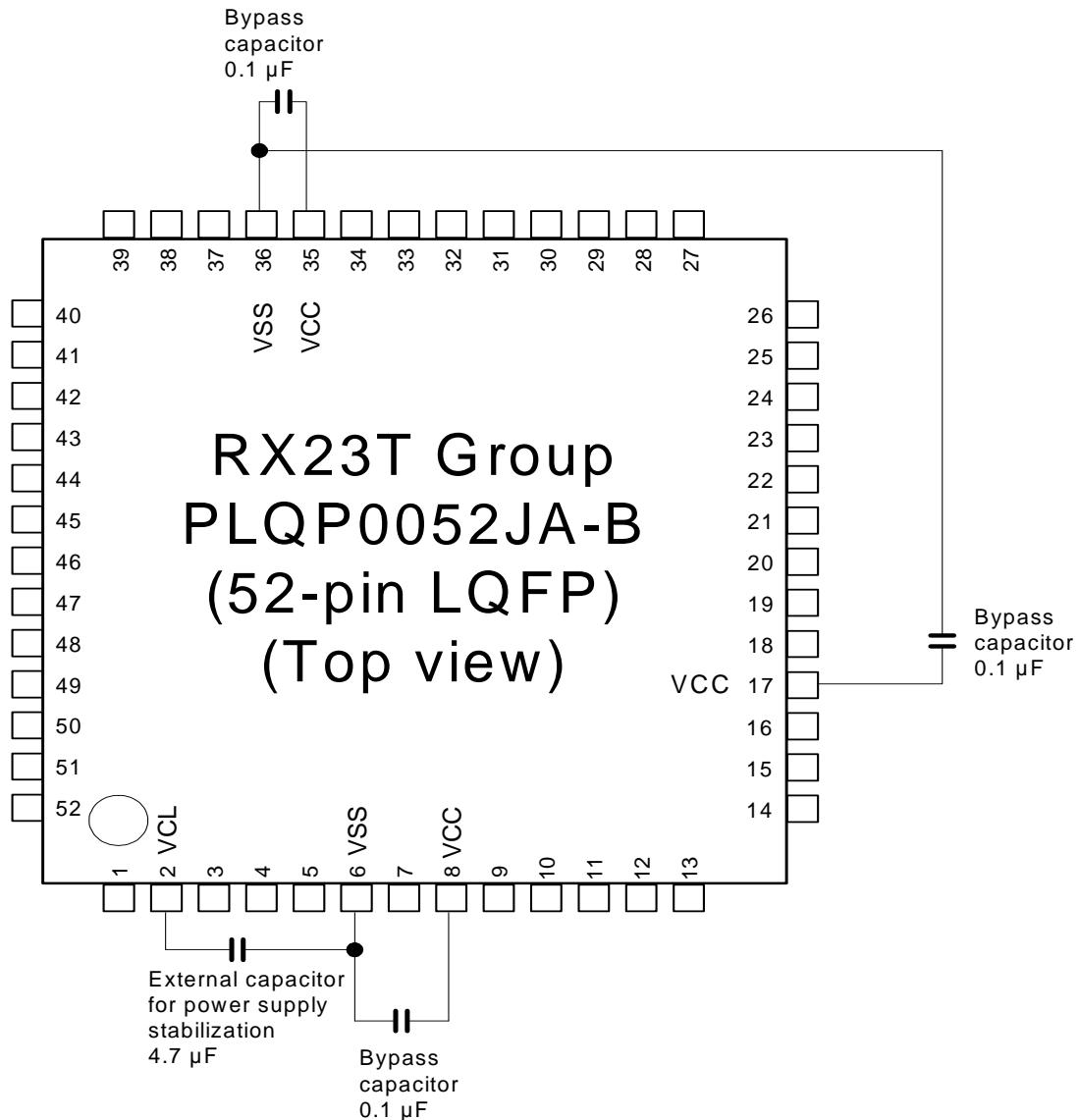
Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V _{POR}	1.35	1.50	1.65	V Figure 5.50, Figure 5.51
	Voltage detection circuit (LVD0) ^{*1}	V _{det0_0}	3.67	3.84	3.97	V
		V _{det0_2}	2.37	2.51	2.67	
	Voltage detection circuit (LVD1) ^{*2}	V _{det1_0}	4.12	4.29	4.42	V Figure 5.53 At falling edge VCC
		V _{det1_1}	3.98	4.14	4.28	
		V _{det1_2}	3.86	4.02	4.16	
		V _{det1_3}	3.68	3.84	3.98	
		V _{det1_4}	2.99	3.10	3.29	
		V _{det1_5}	2.89	3.00	3.19	
		V _{det1_6}	2.79	2.90	3.09	
		V _{det1_7}	2.68	2.79	2.98	
	Voltage detection circuit (LVD2) ^{*1}	V _{det2_0} ^{*2}	4.08	4.29	4.48	Figure 5.54 At falling edge VCC
		V _{det2_1}	3.95	4.14	4.35	
		V _{det2_2}	3.82	4.02	4.22	
		V _{det2_3}	3.62	3.84	4.02	

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol V_{det0_n} denotes the value of the LVDS0[1:0] bits.

Note 2. n in the symbol V_{det1_n} denotes the value of the LVDLVL.R.LVD1LVL[3:0] bits.

Note 3. n in the symbol V_{det2_n} denotes the value of the LVDLVL.R.LVD2LVL[3:0] bits.



Note 1. Do not apply the power supply voltage to the VCL pin.

Note 2. Use a 4.7- μ F multilayer ceramic for the VCL pin and place it close to the pin.

A recommended value is shown for the capacitance of the bypass capacitors.

Figure 5.57 Connecting Capacitors (52 Pins)